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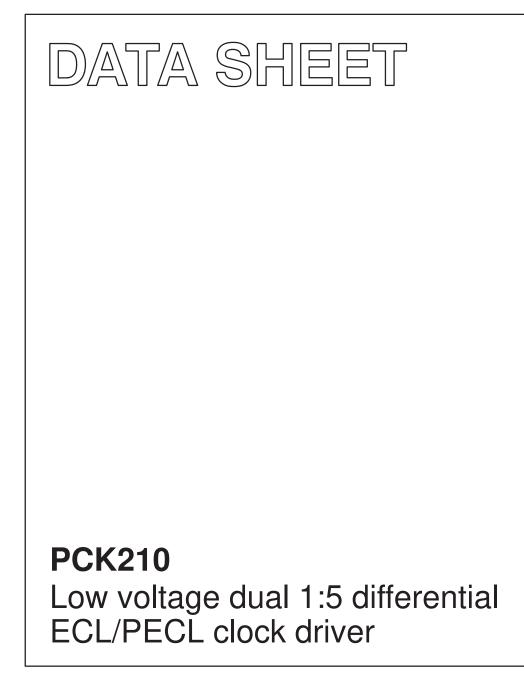


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### INTEGRATED CIRCUITS



Product data Supersedes data of 2002 Dec 13 2004 Apr 23





### PCK210

#### **FEATURES**

- 85 ps part-to-part skew typical
- 20 ps output-to-output skew typical
- Differential design
- V<sub>BB</sub> output
- Voltage and temperature compensated outputs
- Low voltage V<sub>EE</sub> range of –2.25 V to –3.8 V
- 75 kΩ input pull-down resistors
- Form, fit, and function compatible with MC100EP210

#### DESCRIPTION

The PCK210 is a low skew 1-to-5 dual differential driver, designed with clock distribution in mind. The input signals can be either differential or single-ended if the  $V_{BB}$  output is used. The signal is fanned out to 5 identical differential outputs.

The PCK210 is specifically designed, modeled and produced with low skew as the key goal. Optimal design and layout serve to minimize gate-to-gate skew within a device, and empirical modeling is used to determine process control limits that ensure consistent  $t_{PD}$  distributions from lot to lot. The net result is a dependable, guaranteed low skew device.

To ensure that the tight skew specification is met, it is necessary that both sides of the differential output are terminated into 50  $\Omega$ , even if only one side is being used. In most applications, all ten differential pairs will be used, and therefore terminated. In the case where fewer than ten pairs are used, it is necessary to terminate at least the output pairs on the same package side as the pair(s) being used on that side, in order to maintain minimum skew. Failure to do this will result in small degradations of propagation delay (on the order of 10–20 ps) of the output(s) being used, which, while not being catastrophic to most designs, will mean a loss of skew margin.

The PCK210, as with most other ECL devices, can be operated from a positive V<sub>CC</sub> supply in PECL mode. This allows the PCK210 to be used for high performance clock distribution in +3.3 V or +2.5 V systems. Designers can take advantage of the PCK210's performance to distribute low skew clocks across the backplane or the board. In a PECL environment, series or Thevenin line terminations are typically used as they require no additional power supplies.

The PCK210 may be driven single-endedly utilizing the V<sub>BB</sub> bias output with the CLKA or CLKB input. If a single-ended signal is to be used, the V<sub>BB</sub> pin should be connected to the CLKA or CLKB input and bypassed to ground via a 0.01  $\mu$ F capacitor. The V<sub>BB</sub> output can only source/sink 0.3 mA, therefore, it should be used as a switching reference for the PCK210 only. Part-to-part skew specifications are not guaranteed when driving the PCK210 single-endedly.

#### PINNING

#### Pin configurations

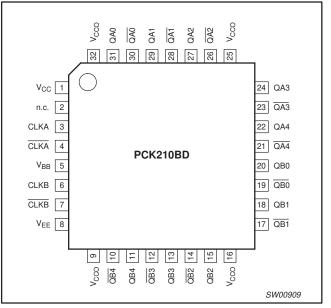


Figure 1. LQFP32 pin configuration

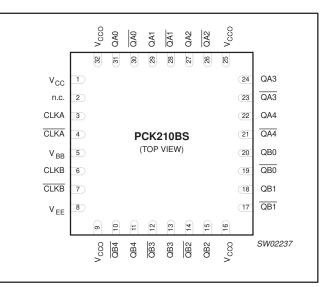


Figure 2. HVQFN32 pin configuration

#### **ORDERING INFORMATION**

Tuno numbor	Package			Temperature
Type number Name		Description	Version	range
PCK210BD	LQFP32	plastic low profile quad flat package; 32 leads; body $7\times7\times1.4~\text{mm}$	SOT358-1	–40 °C to +85 °C
PCK210BS	10BS     HVQFN32     plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 × 5 × 0.85 mm     S		SOT617-1	–40 °C to +85 °C

#### **Pin description**

SYMBOL	PIN	DESCRIPTION
V <sub>CC</sub>	1	Supply voltage
n.c.	2	not connected
CLKA, CLKA	3, 4	Differential input pair
V <sub>BB</sub>	5	V <sub>BB</sub> output
CLKB, CLKB	6, 7	Differential input pair
V <sub>EE</sub>	8	Ground
V <sub>CCO</sub>	9, 16, 25, 32	Output drive power supply voltage
QA0–QA4, QB0–QB4	31, 29, 27, 24, 22, 20, 18, 15, 13, 11	Differential outputs
$\frac{QA0}{QB0} - \frac{QA4}{QB4},$	30, 28, 26, 23, 21, 19, 17, 14, 12, 10	Differential outputs

#### LOGIC SYMBOL

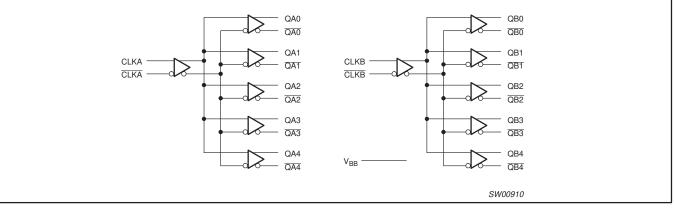


Figure 3. Logic symbol

Product data

PCK210

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	LIM	ITS	UNIT
STMBUL	PANAMETEN	MIN		
V <sub>CC</sub>	Supply voltage	-0.3	+4.6	V
VI	Input voltage	-0.3	V <sub>CC</sub> + 0.3	V
I <sub>IN</sub>	Input current	-	±20	mA
T <sub>stg</sub>	Storage temperature range	-40	+125	°C
ESD <sub>HBM</sub>	Electrostatic discharge (Human Body Model; 1.5 k $\Omega$ , 100 pF)	-	>1750	V
ESD <sub>MM</sub>	Electrostatic discharge (Machine Model; 0 kΩ, 100 pF)	-	>200	V
ESD <sub>CDM</sub>	Electrostatic discharge (Charge Device Model)	-	>1000	V

NOTE:

1. Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2.25	3.8	V
V <sub>IR</sub>	Receiver input voltage		V <sub>EE</sub>	V <sub>CC</sub>	V
V <sub>DIFF</sub>	Input differential voltage <sup>1</sup>	V <sub>(CLKinN)</sub> –V(CLKin)	—	1.00	V
T <sub>amb</sub>	Operating ambient temperature range in free air		-40	+85	°C

NOTE:

 To idle an unused differential clock input, connect one input terminal (e.g. CLK1) to V<sub>BB</sub> and leave its complimentary input terminal (e.g. CLK1) open-circuit, in which case CLK1 will default LOW by its internal pull-down reistor. Inputs should not be shorted to ground or V<sub>CC</sub>.

#### THERMAL CHARACTERISTICS

Proper thermal management is critical for reliable system operation. This is especially true for high fan-out and high drive capability products.

#### DC ELECTRICAL CHARACTERISTICS

 $V_{supply}$ :  $V_{CC}$  =  $V_{CCO}$  = 0.0 V;  $V_{EE}$  = –2.25 V to –3.80 V.

SYMBOL	PARAMETER	CONDITIONS	-40	°C	+25	°C	+85 °C		
SYMBOL	FARAMETER	CONDITIONS	MIN	MAX	MIN	MAX	MIN	MAX	
I <sub>EE</sub>	Internal supply current	Absolute value of current	20	80	20	85	30	90	mA
I <sub>CC</sub>	Output and internal supply current	All outputs terminated 50 $\Omega$ to V <sub>CC</sub> – 2.0 V	270	390	270	395	270	405	mA
I <sub>IN</sub>	Input current	Includes pull-up/pull-down resistors	-	150	-	150	-	150	μA
$V_{BB}$	Internally generated bias voltage	for V <sub>EE</sub> = $-2.25$ V to $-3.8$ V	-1.38	-1.16	-1.38	-1.16	-1.38	-1.16	V
$V_{PP}$	Input amplitude	Difference of input $\approx V_{IH} - V_{IL}$ (Note 1)		1.3	0.5	1.3	0.5	1.3	V
V <sub>CMR</sub>	Common mode voltage	Crosspoint of input ≈ average (V <sub>IH</sub> , V <sub>IL</sub> )	V <sub>EE</sub> + 1.0	-0.3	V <sub>EE</sub> + 1.0	-0.3	V <sub>EE</sub> + 1.0	-0.3	V
V <sub>OH</sub>	HIGH-level output voltage	evel output voltage I <sub>OH</sub> = -30 mA		-0.95	-	-	-1.20	-0.85	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = -5 mA	-1.85	-1.40	-	_	-1.90	-1.50	V
V <sub>OUTpp</sub>	Differential output swing		350	-	-	_	500	_	mV

#### DC ELECTRICAL CHARACTERISTICS

 $V_{supply}$ :  $V_{CC} = V_{CCO} = 2.25$  V to 3.80 V;  $V_{EE} = 0.0$  V.

SYMBOL	PARAMETER	CONDITIONS	-40	)°C	+25	o°C	+85 °C		
STNBOL	FANAMETEN	CONDITIONS	MIN	MAX	MIN	MAX	MIN	MAX	
I <sub>EE</sub>	Internal supply current	Absolute value of current	20	80	20	85	30	90	mA
I <sub>CC</sub>	Output and internal supply current	All outputs terminated 50 $\Omega$ to V <sub>CC</sub> – 2.0 V	270	390	270	395	270	405	mA
I <sub>IN</sub>	Input current	Includes pull-up/ pull-down resistors	-	150	-	150	-	150	μA
$V_{BB}$	Internally generated bias voltage	$V_{CC}$ = 2.25 V to 3.8 V	V <sub>CC</sub> – 1.38	V <sub>CC</sub> – 1.16	V <sub>CC</sub> – 1.38	V <sub>CC</sub> – 1.16	V <sub>CC</sub> – 1.38	V <sub>CC</sub> – 1.16	V
V <sub>PP</sub>	Input amplitude	Difference of input $\approx V_{IH} - V_{IL}$ (Note 1)	0.5	1.3	0.5	1.3	0.5	1.3	V
V <sub>CMR</sub>	Common mode voltage	Crosspoint of input $\approx$ average (V <sub>IH</sub> , V <sub>IL</sub> )	1	$V_{CC} - 0.3$	1	$V_{CC} - 0.3$	1	$V_{\rm CC} - 0.3$	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = -30 mA	V <sub>CC</sub> - 1.30	V <sub>CC</sub> – 0.95	-	-	V <sub>CC</sub> – 1.20	V <sub>CC</sub> – 0.85	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = -5 mA	V <sub>CC</sub> – 1.85	V <sub>CC</sub> - 1.40	-	-	V <sub>CC</sub> – 1.90	V <sub>CC</sub> – 1.50	V
V <sub>OUTpp</sub>	Differential output swing		350	-	-	_	500	-	mV

#### NOTE:

1. V<sub>PP</sub> minimum and maximum required to maintain AC specifications. Actual device function will tolerate minimum V<sub>PP</sub> of 100 mV.

### PCK210

#### AC CHARACTERISTICS — PECL input

 $V_{supply}$ :  $V_{CC} = V_{CCO} = 2.25$  V to 3.80 V;  $V_{EE} = 0.0$  V  $-OR - V_{CC} = V_{CCO} = 0.0$  V;  $V_{EE} = -2.25$  V to -3.80 V.

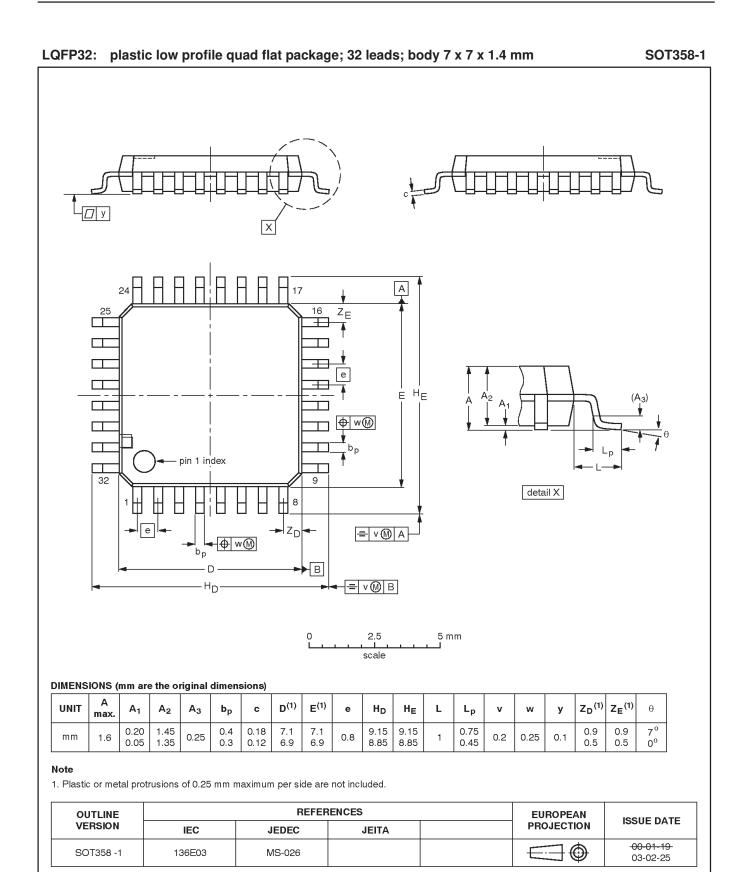
SYMBOL	PARAMETER	CONDITIONS		–40 °C			+25 °C			+85 °C		
STMBUL	FARAMEIEN	CONDITIONS	MIN	TYP	MAX	MIN TYP		MAX	MIN TYP MAX			
t <sub>PD</sub>	Differential propagation delay CLK,CEK to all Q0,Q0 through Q4,Q4	Nominal (single input condition) $V_{PP} = 0.650 V$ , $V_{CMR} = V_{CC} - 0.800 V$ Applies to 500 MHz reference. (Note 1)	270	_	420	300	_	450	380	_	530	ps
t <sub>SK(part)</sub>	Part-to-part skew	Single input condition (Note 1)	-	110		-	-	110	-	-	110	ps
t <sub>SK(output)</sub>	Output-to-output skew for given part	skew Single input condition (Note 1)		15	50	-	15	50	-	15	50	ps
t <sub>PD</sub>	Differential propagation delay CLK,CLK to all $Q0,\overline{Q0}$ through $Q4,\overline{Q4}$	All input conditions (Note 1)	220	-	520	250	-	550	320	_	620	ps
t <sub>SK(part)</sub>	Part-to-part skew	(Note 1)	-	-	160	-	-	160	-	-	160	ps
t <sub>SK(output)</sub>	Output-to-output skew for given part	(Note 1)	-	15	50	-	15	50	-	15	50	ps
t <sub>jitter</sub>	Cyle-to-cycle jitter		-	-	1	-	-	1	-	-	1	ns
f <sub>MAX</sub>	Maximum frequency	Functional to 1.5 GHz Timing specifications apply up to 1.0 GHz	-	-	1500	-	-	1500	-	-	1500	MHz
t <sub>r</sub> , t <sub>f</sub>	Output rise and fall times (20%, 80%)	(Note 1)	100	_	320	100	_	320	100	_	320	ps

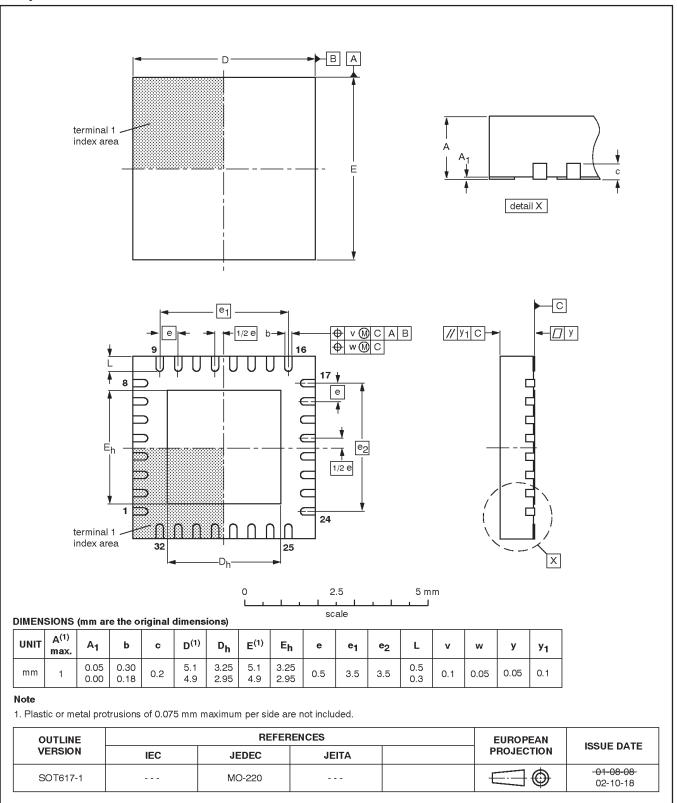
#### NOTE:

1. For operation with 2.5 V supply, the output termination is 50  $\Omega$  to V<sub>EE</sub>. For operation at 3.3 V supply, the output termination is 50  $\Omega$  to V<sub>CC</sub> – 2 V.

Product data

### PCK210





### HVQFN32: plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 x 5 x 0.85 mm

PCK210

SOT617-1

PCK210

#### **REVISION HISTORY**

Rev	Date	Description
_3	20040423	<ul> <li>Product data (9397 750 13083). Supersedes data of 2002 Dec 13 (9397 750 10866).</li> <li>Modifications:</li> <li>Add Part type PCK210BS, HVQFN32 package option (SOT617-1).</li> <li>Change temperature range in Ordering information table on page 2 from "-40 to +70 °C" to "-40 °C to +85 °C".</li> </ul>
_2	20021213	<ul> <li>Product data (9397 750 10866); ECN 853-2336 29225 of 22 November 2002.</li> <li>NOTE: date shown on cover (2002 Nov 13) is incorrect. It should be "2002 Dec 13" as shown on all other pages and this Revision history table.</li> </ul>
_1	20020411	Product data (9397 750 09657); ECN 853-2336 27995 of 11 April 2002.

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Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2] [3]</sup>	Definitions
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